

# MJE13005

Preferred Device

## SWITCHMODE™ Series NPN Silicon Power Transistors

These devices are designed for high-voltage, high-speed power switching inductive circuits where fall time is critical. They are particularly suited for 115 and 220 V SWITCHMODE applications such as Switching Regulator's, Inverters, Motor Controls, Solenoid/Relay drivers and Deflection circuits.

### Features

- $V_{CEO(sus)}$  400 V
- Reverse Bias SOA with Inductive Loads @  $T_C = 100^\circ\text{C}$
- Inductive Switching Matrix 2 to 4 A, 25 and  $100^\circ\text{C}$   $t_c$  @ 3A,  $100^\circ\text{C}$  is 180 ns (Typ)
- 700 V Blocking Capability
- SOA and Switching Applications Information
- Pb-Free Package is Available\*

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO(sus)}$	400	Vdc
Collector-Emitter Voltage	$V_{CEV}$	700	Vdc
Emitter-Base Voltage	$V_{EBO}$	9	Vdc
Collector Current – Continuous	$I_C$	4	Adc
– Peak (Note 1)	$I_{CM}$	8	
Base Current – Continuous	$I_B$	2	Adc
– Peak (Note 1)	$I_{BM}$	4	
Emitter Current – Continuous	$I_E$	6	Adc
– Peak (Note 1)	$I_{EM}$	12	
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	2 16	W W/ $^\circ\text{C}$
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	75 600	W W/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-65 to +150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1.67	$^\circ\text{C}/\text{W}$
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 5 Seconds	$T_L$	275	$^\circ\text{C}$

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. Pulse Test: Pulse Width = 5 ms, Duty Cycle  $\leq$  10%.

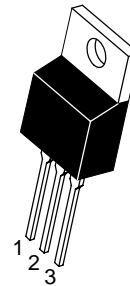
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



ON Semiconductor®

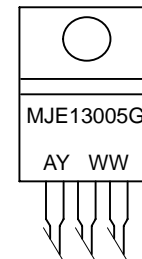
<http://onsemi.com>

**4 AMPERE  
NPN SILICON  
POWER TRANSISTOR  
400 VOLTS – 75 WATTS**



TO-220AB  
CASE 221A-09  
STYLE 1

### MARKING DIAGRAM



A = Assembly  
Location  
Y = Year  
WW = Work Week  
G = Pb-Free Pack-

### age ORDERING INFORMATION

Device	Package	Shipping
MJE13005	TO-220	50 Units / Rail
MJE13005G	TO-220 (Pb-Free)	50 Units / Rail

Preferred devices are recommended choices for future use and best overall value.

# MJE13005

## ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
<b>OFF CHARACTERISTICS</b> (Note 2)					
Collector–Emitter Sustaining Voltage ( $I_C = 10\text{ mA}$ , $I_B = 0$ )	$V_{CEO(sus)}$	400	–	–	Vdc
Collector Cutoff Current ( $V_{CEV} = \text{Rated Value}$ , $V_{BE(off)} = 1.5\text{ Vdc}$ ) ( $V_{CEV} = \text{Rated Value}$ , $V_{BE(off)} = 1.5\text{ Vdc}$ , $T_C = 100^\circ\text{C}$ )	$I_{CEV}$	–	–	1 5	mAdc
Emitter Cutoff Current ( $V_{EB} = 9\text{ Vdc}$ , $I_C = 0$ )	$I_{EBO}$	–	–	1	mAdc

## SECOND BREAKDOWN

Second Breakdown Collector Current with base forward biased	$I_{S/b}$	–	See Figure 11		
Clamped Inductive SOA with Base Reverse Biased	RBSOA	–	See Figure 12		

## ON CHARACTERISTICS

 (Note 2)

DC Current Gain ( $I_C = 1\text{ Adc}$ , $V_{CE} = 5\text{ Vdc}$ ) ( $I_C = 2\text{ Adc}$ , $V_{CE} = 5\text{ Vdc}$ )	$h_{FE}$	10 8	– –	60 40	–
Collector–Emitter Saturation Voltage ( $I_C = 1\text{ Adc}$ , $I_B = 0.2\text{ Adc}$ ) ( $I_C = 2\text{ Adc}$ , $I_B = 0.5\text{ Adc}$ ) ( $I_C = 4\text{ Adc}$ , $I_B = 1\text{ Adc}$ ) ( $I_C = 2\text{ Adc}$ , $I_B = 0.5\text{ Adc}$ , $T_C = 100^\circ\text{C}$ )	$V_{CE(sat)}$	– – – –	– – – –	0.5 0.6 1 1	Vdc
Base–Emitter Saturation Voltage ( $I_C = 1\text{ Adc}$ , $I_B = 0.2\text{ Adc}$ ) ( $I_C = 2\text{ Adc}$ , $I_B = 0.5\text{ Adc}$ ) ( $I_C = 2\text{ Adc}$ , $I_B = 0.5\text{ Adc}$ , $T_C = 100^\circ\text{C}$ )	$V_{BE(sat)}$	– – –	– – –	1.2 1.6 1.5	Vdc

## DYNAMIC CHARACTERISTICS

Current–Gain – Bandwidth Product ( $I_C = 500\text{ mAdc}$ , $V_{CE} = 10\text{ Vdc}$ , $f = 1\text{ MHz}$ )	$f_T$	4	–	–	MHz
Output Capacitance ( $V_{CB} = 10\text{ Vdc}$ , $I_E = 0$ , $f = 0.1\text{ MHz}$ )	$C_{ob}$	–	65	–	pF

## SWITCHING CHARACTERISTICS

<b>Resistive Load</b> (Table 2)						
Delay Time	$(V_{CC} = 125\text{ Vdc}$ , $I_C = 2\text{ A}$ , $I_{B1} = I_{B2} = 0.4\text{ A}$ , $t_p = 25\text{ }\mu\text{s}$ , Duty Cycle $\leq 1\%$ )	$t_d$	–	0.025	0.1	$\mu\text{s}$
Rise Time		$t_r$	–	0.3	0.7	$\mu\text{s}$
Storage Time		$t_s$	–	1.7	4	$\mu\text{s}$
Fall Time		$t_f$	–	0.4	0.9	$\mu\text{s}$
<b>Inductive Load, Clamped</b> (Table 2, Figure 13)						
Voltage Storage Time	$(I_C = 2\text{ A}$ , $V_{clamp} = 300\text{ Vdc}$ , $I_{B1} = 0.4\text{ A}$ , $V_{BE(off)} = 5\text{ Vdc}$ , $T_C = 100^\circ\text{C}$ )	$t_{sv}$	–	0.9	4	$\mu\text{s}$
Crossover Time		$t_c$	–	0.32	0.9	$\mu\text{s}$
Fall Time		$t_{fi}$	–	0.16	–	$\mu\text{s}$

2. Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2%.

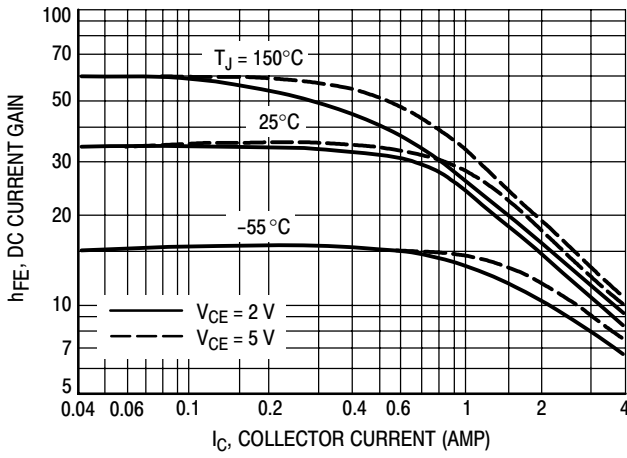


Figure 1. DC Current Gain

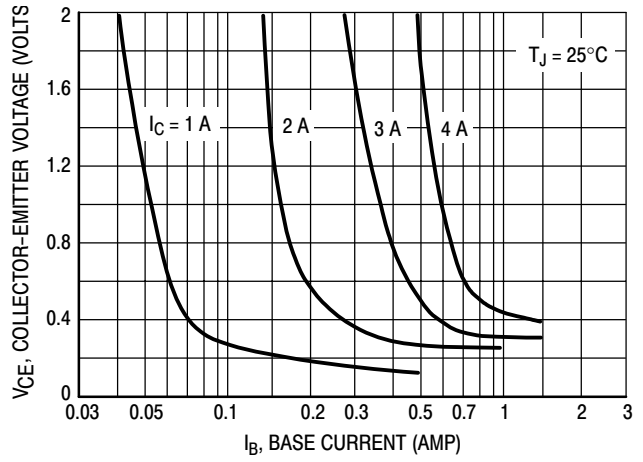


Figure 2. Collector Saturation Region

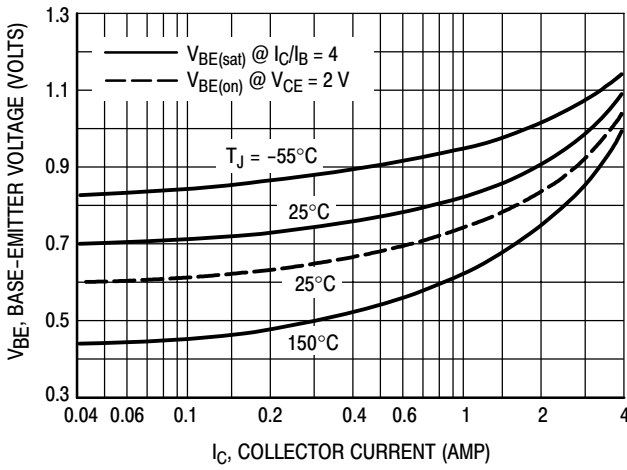


Figure 3. Base-Emitter Voltage

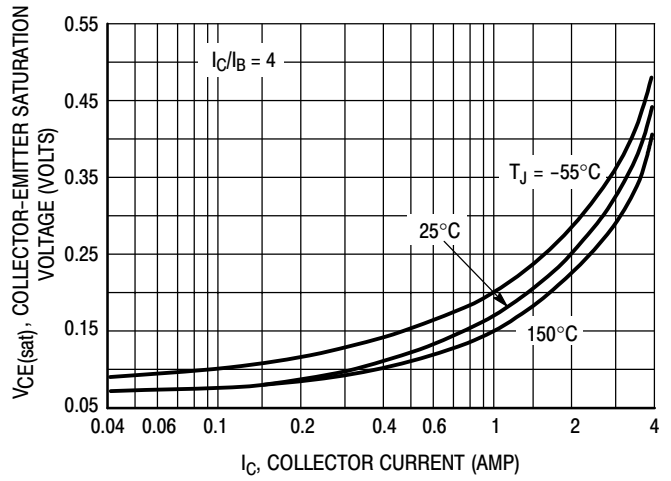


Figure 4. Collector-Emitter Saturation Voltage

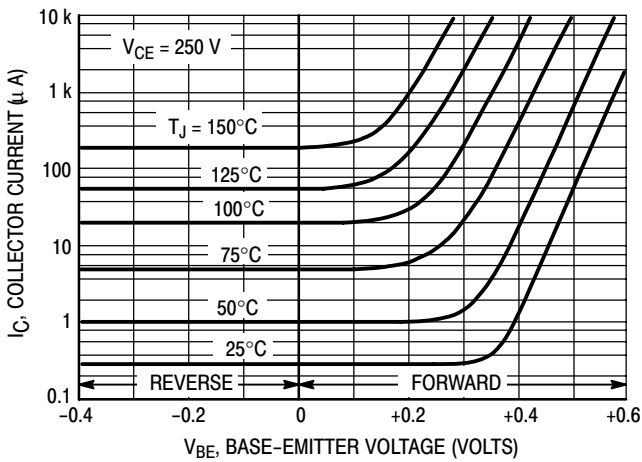


Figure 5. Collector Cutoff Region

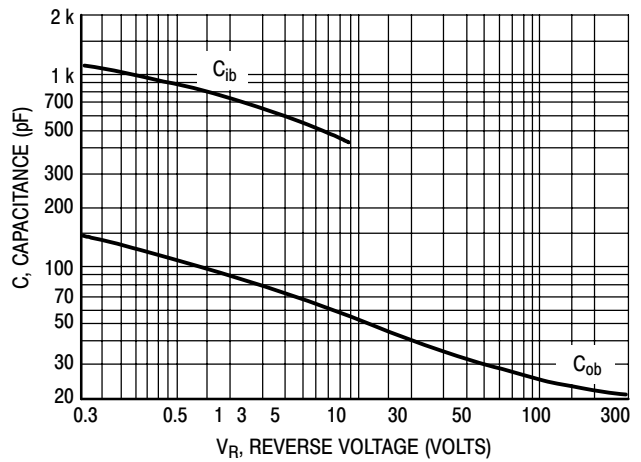


Figure 6. Capacitance

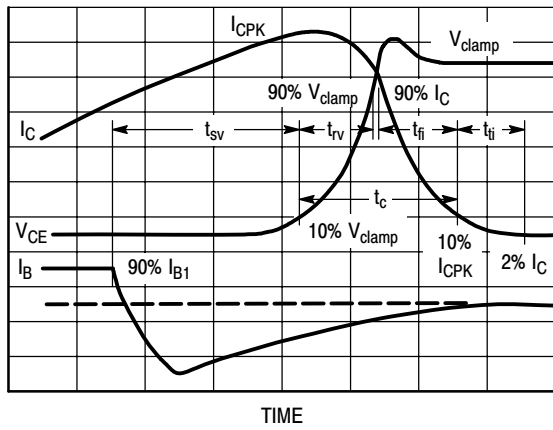


Figure 7. Inductive Switching Measurements

Table 1. Typical Inductive Switching Performance

I <sub>C</sub> AMP	T <sub>C</sub> °C	t <sub>sv</sub> ns	t <sub>rv</sub> ns	t <sub>fi</sub> ns	t <sub>ti</sub> ns	t <sub>c</sub> ns
2	25	600	70	100	80	180
	100	900	110	240	130	320
3	25	650	60	140	60	200
	100	950	100	330	100	350
4	25	550	70	160	100	220
	100	850	110	350	160	390

NOTE: All Data recorded in the inductive Switching Circuit In Table 2.

**SWITCHING TIMES NOTE**

In resistive switching circuits, rise, fall, and storage times have been defined and apply to both current and voltage waveforms since they are in phase. However, for inductive loads which are common to SWITCHMODE power supplies and hammer drivers, current and voltage waveforms are not in phase. Therefore, separate measurements must be made on each waveform to determine the total switching time. For this reason, the following new terms have been defined.

t<sub>sv</sub> = Voltage Storage Time, 90% I<sub>B1</sub> to 10% V<sub>clamp</sub>

t<sub>rv</sub> = Voltage Rise Time, 10–90% V<sub>clamp</sub>

t<sub>fi</sub> = Current Fall Time, 90–10% I<sub>C</sub>

t<sub>ti</sub> = Current Tail, 10–2% I<sub>C</sub>

t<sub>c</sub> = Crossover Time, 10% V<sub>clamp</sub> to 10% I<sub>C</sub>

An enlarged portion of the inductive switching waveforms is shown in Figure 7 to aid in the visual identity of these terms.

For the designer, there is minimal switching loss during storage time and the predominant switching power losses occur during the crossover interval and can be obtained using the standard equation from AN–222:

$$P_{SWT} = 1/2 V_{CC}I_C(t_c)f$$

In general, t<sub>rv</sub> + t<sub>fi</sub> ≈ t<sub>c</sub>. However, at lower test currents this relationship may not be valid.

As is common with most switching transistors, resistive switching is specified at 25°C and has become a benchmark for designers. However, for designers of high frequency converter circuits, the user oriented specifications which make this a “SWITCHMODE” transistor are the inductive switching speeds (t<sub>c</sub> and t<sub>sv</sub>) which are guaranteed at 100°C.

**RESISTIVE SWITCHING PERFORMANCE**

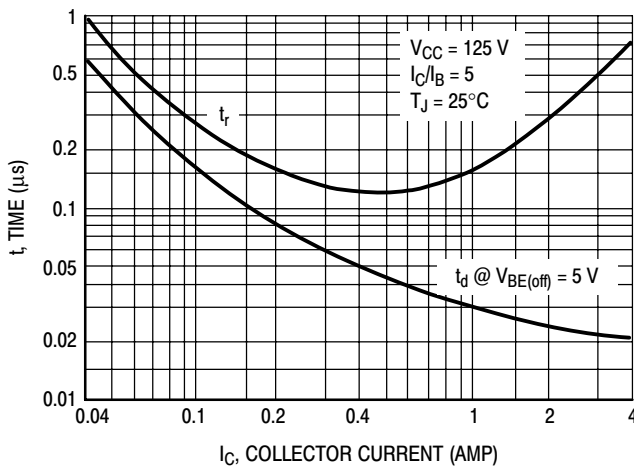


Figure 8. Turn-On Time

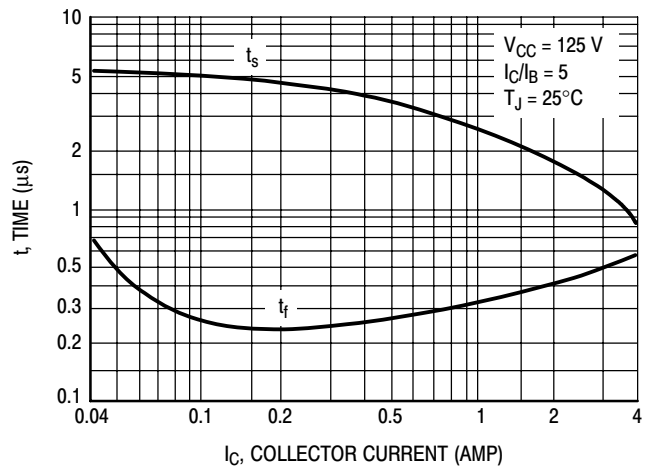


Figure 9. Turn-Off Time

# MJE13005

Table 2. Test Conditions for Dynamic Performance

	REVERSE BIAS SAFE OPERATING AREA AND INDUCTIVE SWITCHING	RESISTIVE SWITCHING
<b>TEST CIRCUITS</b>	<p>DUTY CYCLE <math>\leq 10\%</math>  <math>t_r, t_f \leq 10 \text{ ns}</math></p> <p>NOTE          PW and <math>V_{CC}</math> Adjusted for Desired <math>I_C</math>  <math>R_B</math> Adjusted for Desired <math>I_{B1}</math></p>	
<b>CIRCUIT VALUES</b>	<p>Coil Data:          Ferroxcube Core #6656          Full Bobbin (~16 Turns) #16</p> <p>GAP for 200 <math>\mu\text{H}/20 \text{ A}</math>  <math>L_{\text{coil}} = 200 \mu\text{H}</math></p> <p><math>V_{CC} = 20 \text{ V}</math>  <math>V_{\text{clamp}} = 300 \text{ Vdc}</math></p>	<p><math>V_{CC} = 125 \text{ V}</math>  <math>R_C = 62 \Omega</math>  <math>D1 = 1\text{N}5820</math> or Equiv.  <math>R_B = 22 \Omega</math></p>
<b>TEST WAVEFORMS</b>	<p><b>OUTPUT WAVEFORMS</b></p> <p><math>t_1</math> ADJUSTED TO OBTAIN <math>I_C</math>  <math>t_1 \approx \frac{L_{\text{coil}} (I_{Cpk})}{V_{CC}}</math></p> <p><math>t_2 \approx \frac{L_{\text{coil}} (I_{Cpk})}{V_{\text{clamp}}}</math></p> <p>Test Equipment          Scope-Tektronics          475 or Equivalent</p>	<p><math>t_p, t_f &lt; 10 \text{ ns}</math>          Duty Cycle = 1.0%  <math>R_B</math> and <math>R_C</math> adjusted for desired <math>I_B</math> and <math>I_C</math></p>

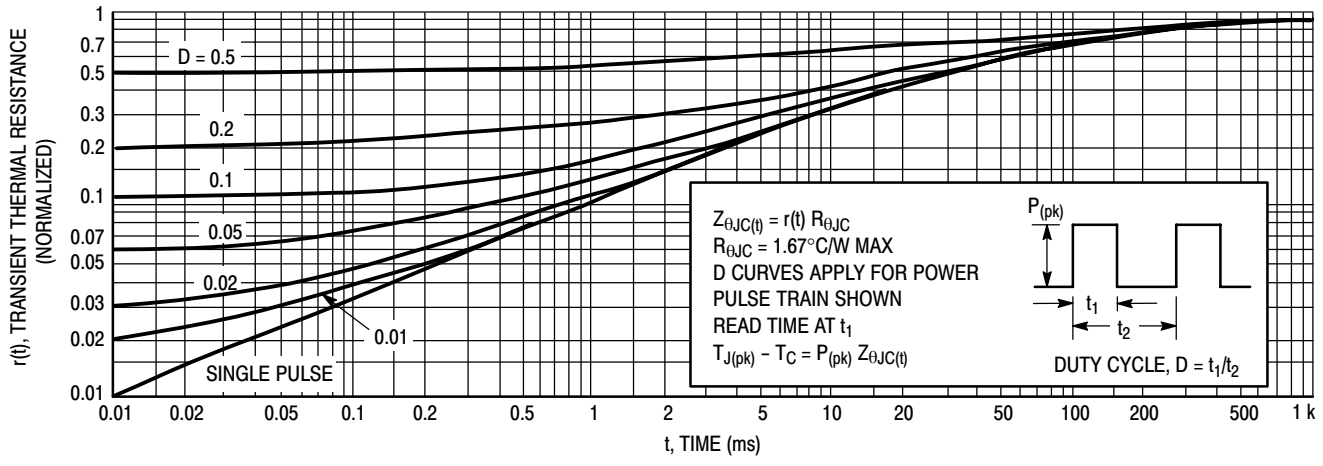


Figure 10. Typical Thermal Response [ $Z_{\theta JC}(t)$ ]

Downloaded from [Elcodis.com](http://Elcodis.com) electronic components distributor

SAFE OPERATING AREA INFORMATION

The Safe Operating Area Figures 11 and 12 are specified ratings for these devices under the test conditions shown.

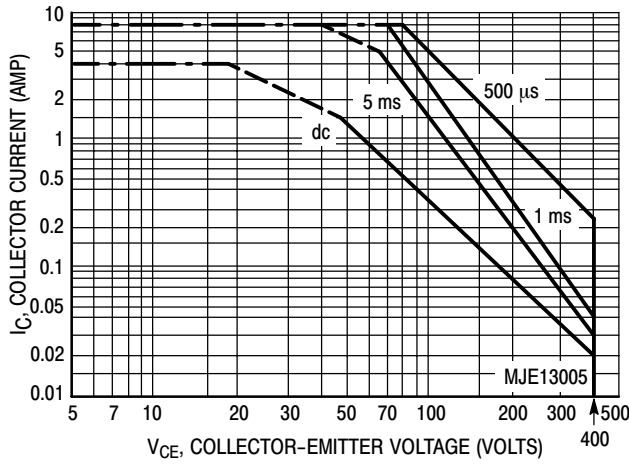


Figure 11. Forward Bias Safe Operating Area

FORWARD BIAS

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 11 is based on  $T_C = 25^\circ\text{C}$ ;  $T_{J(pk)}$  is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when  $T_C \geq 25^\circ\text{C}$ . Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 11 may be found at any case temperature by using the appropriate curve on Figure 13.

$T_{J(pk)}$  may be calculated from the data in Figure 10. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

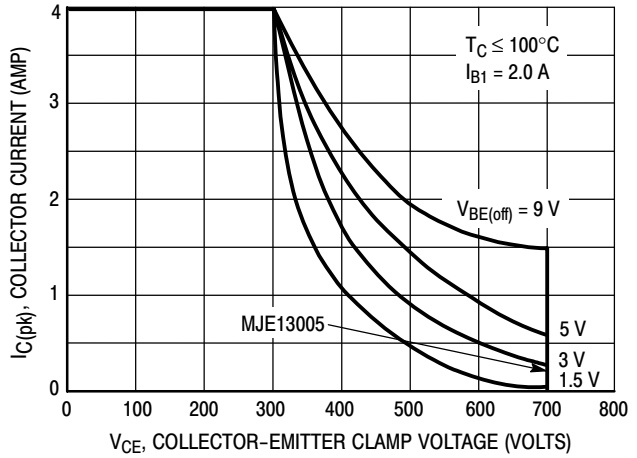


Figure 12. Reverse Bias Switching Safe Operating Area

REVERSE BIAS

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current conditions during reverse biased turn-off. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 12 gives the complete RBSOA characteristics.

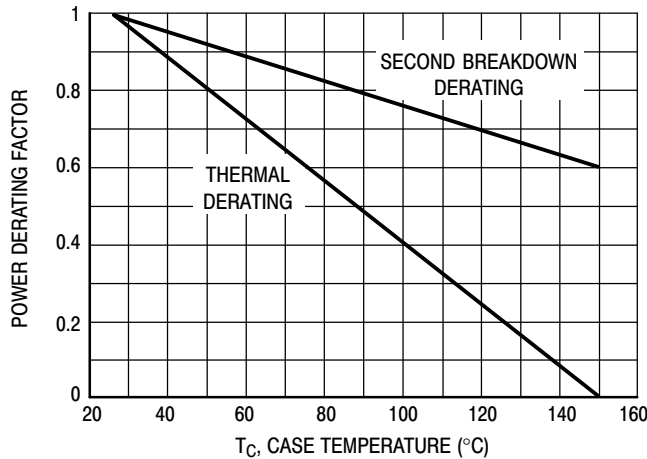
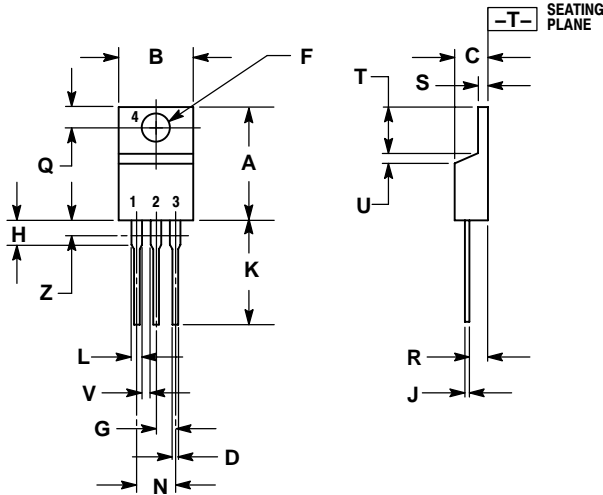


Figure 13. Forward Bias Power Derating

# MJE13005

## PACKAGE DIMENSIONS

### TO-220AB CASE 221A-09 ISSUE AA



#### NOTES:


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

#### STYLE 1:

1. BASE
2. COLLECTOR
3. EMITTER
4. COLLECTOR

SWITCHMODE is a trademark of Semiconductor Components Industries, LLC.

**ON Semiconductor** and  are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

**LITERATURE FULFILLMENT:**  
Literature Distribution Center for ON Semiconductor  
P.O. Box 61312, Phoenix, Arizona 85082-1312 USA  
**Phone:** 480-829-7710 or 800-344-3860 Toll Free USA/Canada  
**Fax:** 480-829-7709 or 800-344-3867 Toll Free USA/Canada  
**Email:** orderlit@onsemi.com

**N. American Technical Support:** 800-282-9855 Toll Free  
USA/Canada

**Japan:** ON Semiconductor, Japan Customer Focus Center  
2-9-1 Kamimeguro, Meguro-ku, Tokyo, Japan 153-0051  
**Phone:** 81-3-5773-3850

**ON Semiconductor Website:** <http://onsemi.com>

**Order Literature:** <http://www.onsemi.com/litorder>

For additional information, please contact your local Sales Representative.

**MJE13005/D**